TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74AC245P, TC74AC245F, TC74AC245FT TC74AC640P, TC74AC640F, TC74AC640FT

Octal Bus Transceiver

TC74AC245P/F/FT 3-State, Non-Inverting TC74AC640P/F/FT 3-State, Inverting

The TC74AC245, 640 are advanced high speed CMOS OCTAL BUS TRANSCEIVERs fabricated with silicon gate and double-layer metal wiring C<sup>2</sup>MOS technology.

They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

They are intended for two-way asynchronous communication between data busses. The direction of data transmission is determined by the level of the DIR input.

The enable input (  $\overline{\mathbb{G}}$  ) can be used to disable the device so that the busses are effectively isolated.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

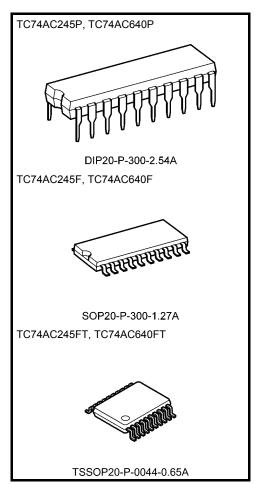
#### Features (Note 1)(Note 2)

- High speed:  $t_{pd} = 3.9$  ns (typ.) at  $V_{CC} = 5$  V
- Low power dissipation:  $I_{CC} = 8 \mu A \text{ (max)}$  at  $Ta = 25^{\circ}C$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% \ V_{CC}$  (min)
- Symmetrical output impedance:
   |I<sub>OH</sub>| = I<sub>OL</sub> = 24 mA (min)

Capability of driving 50  $\Omega$  transmission lines.

- Balanced propagation delays: t<sub>pLH</sub> ≈ t<sub>pHL</sub>
- Wide operating voltage range: V<sub>CC</sub> (opr) = 2 V to 5.5 V
- Pin and function compatible with 74F245/640
  - Note 1: Do not apply a signal to any bus terminal when it is in the output mode. Damage may result.

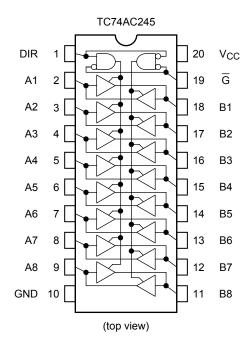
Note 2: All floating (high impedance) bus terminals must have their input levels fixed by means of pull up or pull down resistors.

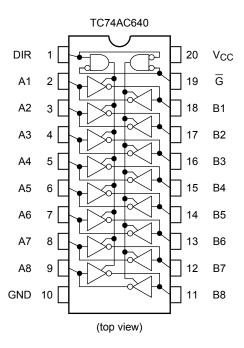


Weight

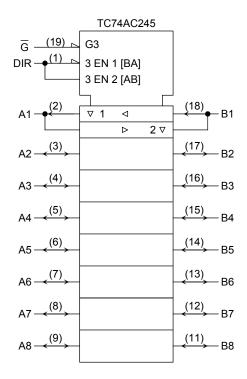
DIP20-P-300-2.54A : 1.30 g (typ.) SOP20-P-300-1.27A : 0.22 g (typ.) TSSOP20-P-0044-0.65A : 0.08 g (typ.)

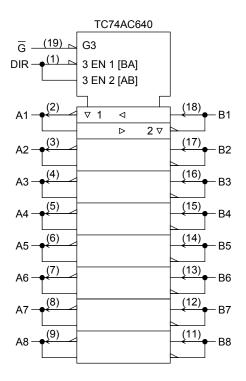
#### **Pin Assignment**





#### **IEC Logic Symbol**





#### **Truth Table**

Inputs		Fun	ction	Outputs			
G	DIR	A Bus	B Bus	AC245	AC640		
L	L	Output	Input	A = B	$A = \overline{B}$		
L	Н	Input	Output	B = A	$B = \overline{A}$		
Н	Х	2	<u> </u>	Z	Z		

X: Don't care

Z: High impedance

#### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	$V_{CC}$	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	lok	±50	mA
DC output current	lout	±50	mA
DC V <sub>CC</sub> /ground current	Icc	±200	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP/TSSOP)	mW
Storage temperature	T <sub>stg</sub>	−65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta =  $-40^{\circ}$ C to 65°C. From Ta = 65°C to 85°C a derating factor of -10 mW/°C should be applied up to 300 mW.

#### **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit	
Supply voltage	$V_{CC}$	2.0 to 5.5	V	
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	٧	
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	٧	
Operating temperature	T <sub>opr</sub>	−40 to 85	ç	
Input rise and fall time	dt/dV	0 to 100 (V <sub>CC</sub> = 3.3 ± 0.3 V)	ns/V	
input rise and rail tille	uvuv	0 to 20 ( $V_{CC} = 5 \pm 0.5 \text{ V}$ )		

Note: The operating ranges are required to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either  $V_{CC}$  or GND. Please connect both bus inputs and the bus outputs with  $V_{CC}$  or GND when the I/O of the bus terminal changes by the function. In this case, please note that the output is not short-circuited.

3



#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit	
Sharastonistics	- Cymbol			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Offic	
		_		2.0	1.50	_	_	1.50	_	٧	
High-level input voltage	$V_{IH}$			3.0	2.10	_	_	2.10	_		
				5.5	3.85	_	_	3.85	_		
		_		2.0	_	_	0.50	_	0.50		
Low-level input voltage	$V_{IL}$			3.0	_	_	0.90	_	0.90	V	
C				5.5	-	_	1.65	_	1.65		
					2.0 1.9 2.0	_	1.9	_			
	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA		3.0	2.9	3.0	_	2.9	_	- v
High-level output					4.5	4.4	4.5	_	4.4	_	
voltage			I <sub>OH</sub> = -4 mA		3.0	2.58	_	_	2.48	_	
			I <sub>OH</sub> = −24 mA		4.5	3.94	_	_	3.80	_	
			I <sub>OH</sub> = -75 mA	(Note)	5.5	_	_	_	3.85	_	
	VoL	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>			2.0	_	0.0	0.1	_	0.1	· v
			I <sub>OL</sub> = 50 μA		3.0	_	0.0	0.1	_	0.1	
Low-level output					4.5	_	0.0	0.1	_	0.1	
voltage			I <sub>OL</sub> = 12 mA		3.0	_	_	0.36	_	0.44	
			I <sub>OL</sub> = 24 mA		4.5	_	_	0.36	_	0.44	
			I <sub>OL</sub> = 75 mA	(Note)	5.5	_	_	_	_	1.65	
3-state output off-state current	I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = V <sub>CC</sub> or GND		5.5	_	_	±0.5	_	±5.0	μΑ	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	±0.1	_	±1.0	μΑ	
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	8.0	_	80.0	μΑ	

Note: This spec indicates the capability of driving 50  $\Omega$  transmission lines.

One output should be tested at a time for a 10 ms maximum duration.



#### AC Characteristics ( $C_L$ = 50 pF, $R_L$ = 500 $\Omega$ , input: $t_r$ = $t_f$ = 3 ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = −40 to 85°C		Unit
	- <b>,</b>		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
Propagation delay	t <sub>pLH</sub>		$3.3 \pm 0.3$	_	7.0	10.9	1.0	12.4	no
time (Note 2)	$t_{pHL}$	_	5.0 ± 0.5	_	5.0	7.5	1.0	8.5	ns
Propagation delay	t <sub>pLH</sub>	_	$3.3 \pm 0.3$	_	6.4	10.0	1.0	11.4	ns
time (Note 3)	$t_{pHL}$		5.0 ± 0.5	_	4.8	7.0	1.0	8.0	
Outrout analyla time	t <sub>pZL</sub>	_	$3.3 \pm 0.3$	_	9.3	15.3	1.0	17.4	ns
Output enable time	$t_{pZH}$		5.0 ± 0.5	_	7.1	10.5	1.0	12.0	
Output disable time	t <sub>pLZ</sub>	_	$3.3 \pm 0.3$	_	7.1	11.4	1.0	13.0	ns
Output disable time	$t_{pHZ}$		5.0 ± 0.5	_	5.9	8.7	1.0	10.0	
Input capacitance	C <sub>IN</sub>	DIR, G		_	5	10	_	10	pF
Bus input capacitance	C <sub>I/O</sub>	A <sub>n</sub> , Bn		_	13	_	_	_	pF
Power dissipation	C <sub>PD</sub>	TC74AC245		_	38	_	_	_	nE.
capacitance	(Note 1)	TC74AC640		_	36	_		_	pF

Note 1: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

5

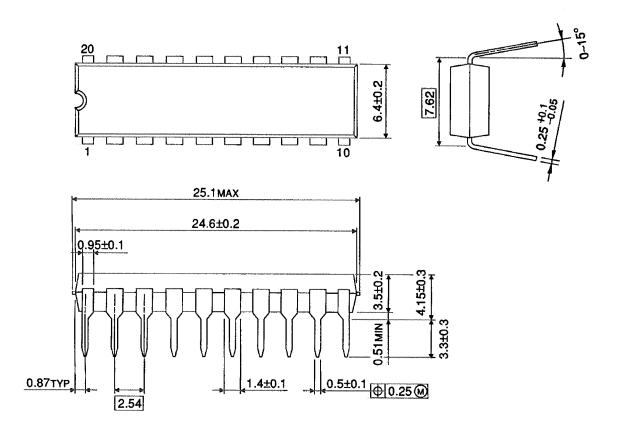
Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} \cdot I_{CC} / 8$  (per bit)

Note 2: For TC74AC245 only
Note 3: For TC74AC640 only

## **Package Dimensions**

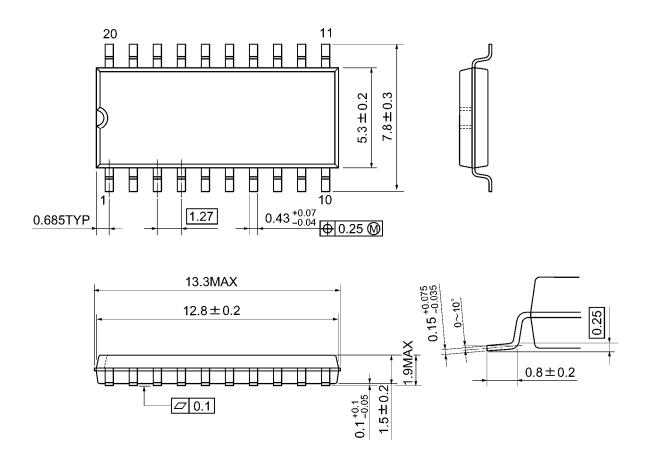
DIP20-P-300-2.54A Unit: mm



Weight: 1.30 g (typ.)

## **Package Dimensions**

SOP20-P-300-1.27A Unit: mm

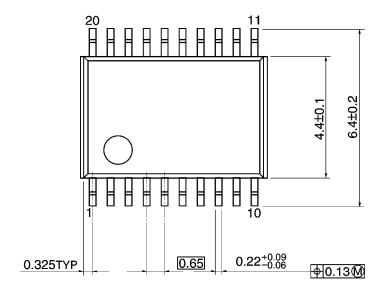


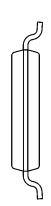
Weight: 0.22 g (typ.)

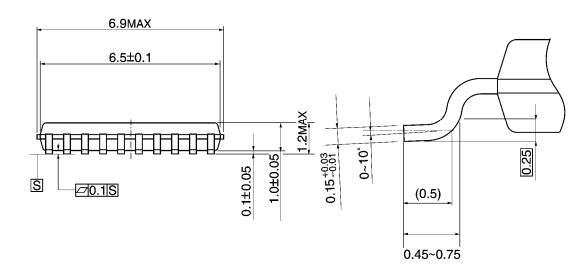
## **Package Dimensions**

TSSOP20-P-0044-0.65A

Unit: mm







Weight: 0.08 g (typ.)

#### RESTRICTIONS ON PRODUCT USE

- Toshiba Corporation, and its subsidiaries and affiliates (collectively "TOSHIBA"), reserve the right to make changes to the information in this document, and related hardware, software and systems (collectively "Product") without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE
  EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH
  MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT
  ("UNINTENDED USE"). Except for specific applications as expressly stated in this document, Unintended Use includes, without
  limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, medical equipment, equipment used for
  automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions,
  safety devices, elevators and escalators, devices related to electric power, and equipment used in finance-related fields. IF YOU USE
  PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT. For details, please contact your
  TOSHIBA sales representative.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any
  applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE
  FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY
  WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR
  LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND
  LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO
  SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS
  FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.
   Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES
   OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.

9

## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Bus Transceivers category:

Click to view products by Toshiba manufacturer:

Other Similar products are found below:

74LS645N DS8838 FXL4TD245UMX IDT74CBTLV3257PGG 74LVT245BBT20-13 5962-8683401DA PCA9617ADMR2G 5962-8953501KA 5962-86834012A 5962-7802301Q2A 5962-7802002MFA 5962-7802001MFA 74VHCV245FT(BJ) NCV7349D13R2G TC74VCX164245(EL,F MC74LCX245MNTWG TC7WPB8306L8X,LF(S TC7WPB9307FC(TE85L 74FCT16245CTPVG8 74FCT16543CTPVG 74FCT245CTPYG8 MM74HC245AMTCX 74LVCH16245APVG 74LVX245MTC 5962-9221405M2A NTS0102DP-Q100H 74ALVC16245MTDX 74ALVCH32245BF 74FCT163245APVG 74FCT245ATPYG8 74FCT245CTQG 74FCT3245AQG 74LCXR162245MTX 74VHC245M 74VHC245MX TC7WPB9306FC(TE85L TC7WPB9306FK(T5L,F JM38510/65553BRA ST3384EBDR 74LVC1T45GF,132 74AVC4TD245BQ,115 PQJ7980AHN/C0JL,51 MC100EP16VBDG FXL2TD245L10X 74LVC1T45GM,115 TC74AC245P(F) PSB21150F S LLHR SNJ54LS245FK SNJ54AHC245J SNJ54ABT245AFK